

### Description

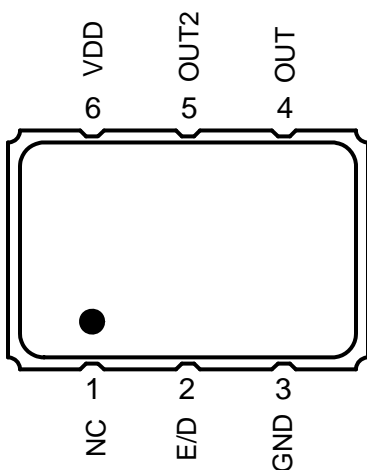
The XUM is an Ultra Precision LVDS crystal oscillator with 300fs typical phase jitter over 12kHz to 20MHz bandwidth. Available in a wide frequency range from 16kHz to 1500MHz, the IDT XUM series crystal oscillator utilizes a family of proprietary ASICs, with a key focus on noise reduction technologies.

The 4th order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional bulk Quartz and SAW oscillators. With short lead-time, low cost, low noise, wide frequency range, excellent ambient performance, the XUM is an excellent choice over the conventional technologies. The XUM has stabilities as tight as  $\pm 20\text{ppm}$  with extremely quick delivery for both standard and custom frequencies

### Features

- Frequency range: 0.016 to 1500MHz
- Output type: LVDS
- Frequency stability:  $\pm 20\text{ppm}$ ,  $\pm 25\text{ppm}$ ,  $\pm 50\text{ppm}$ , or  $\pm 100\text{ppm}$
- Supply voltage: 1.8V, 2.5V, or 3.3V
- Phase jitter (1.875MHz to 20MHz): 100fs typical
- Phase jitter (12kHz to 20MHz): 300fs typical
- Package options: 5.0mm x 3.2mm x 1.2mm (JS6)  
7.0mm x 5.0mm x 1.3mm (JU6)
- Operating temperatures:  $-20^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$  or  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

### Pin Assignment



6-pin CLCC

### Pin Descriptions

Pin Number	Pin Name	Description
1	NC	No connect
2	E/D	Enable/Disable <sup>1</sup> (0=Output Disabled)
3	GND	Connect to ground
4	OUT	Output
5	OUT2	Complementary output
6	VDD	Supply Voltage

1. Pulled high internally.

## Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the XUM. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
VDD	-0.5 to +5.0V
E/D	-0.5V to VDD + 0.5V
OUT	-0.5V to VDD + 0.5V
Storage Temperature	-55°C to 125°C
Theta Ja (Junction to Ambient)	102°C/W – Still Air

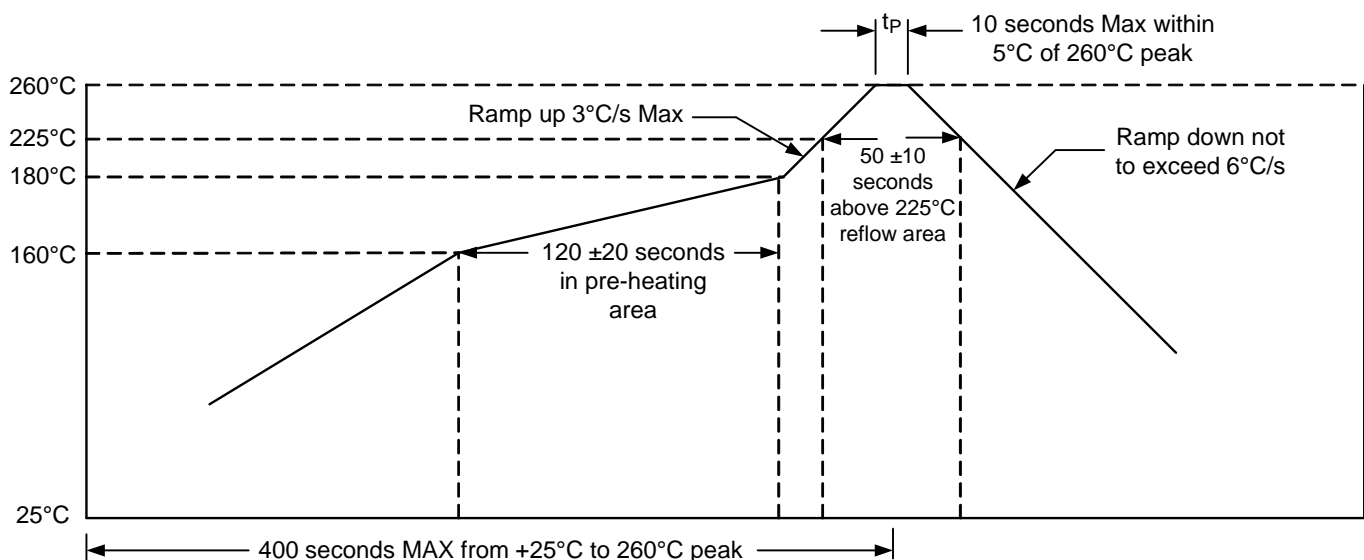
## ESD Compliance

Human Body Model (HBM)	1000V
Machine Model (MM)	150V

## Mechanical Testing

Parameter	Test Method
Mechanical Shock	Half-Sine wave with 0.3ms 3000G X, Y, Z each direction 1 time
Mechanical Vibration	Frequency: 10 to 55 MHz Amplitude: 1.5mm Frequency: 55~2000Hz Peak value: 20G Duration time: 4H for each X,Y,Z axis Total 12hours
High Temp Operating Life (HTOL)	2000 Hours 125°C (under power)
Hermetic Seal	Gross leak (Air leak test) Fine leak (Helium leak test) He-pressure: 6kgf/cm <sup>2</sup> 2 hours

## Solder Reflow Profile



## DC Characteristics

( $V_{DD} = 3.3V \pm 5\%$ ,  $T_A = -20^\circ C$  to  $+70^\circ C$ ;  $-40^\circ$  to  $+85^\circ C$ ). Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	$I_{DD}$	Standard Frequencies		79	97	mA
Differential Output Voltage	$V_{OD}$	Std LVDS load	0.25	0.5	0.6	V
Output Offset Voltage	$V_{OS}$	Std LVDS load	1.0	1.17	1.375	V
Enable/Disable Input HIGH Voltage (Output enabled)*	$V_{IH}$		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	$V_{IL}$				$30\%V_{DD}$	V

\* A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

## AC Characteristics

( $V_{DD} = 3.3V \pm 5\%$ ,  $T_A = -20^\circ C$  to  $+70^\circ C$ ;  $-40^\circ$  to  $+85^\circ C$ ). Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	$F_{OUTR}$		0.016		1500	MHz
Frequency Stability		Temperature = $-20^\circ C$ to $+70^\circ C$	$\pm 20$		$\pm 100$	ppm
		Temperature = $-40^\circ C$ to $+85^\circ C$	$\pm 25$		$\pm 100$	ppm
Aging (1 <sup>st</sup> year)		$T_a = 25^\circ C$			$\pm 3$	ppm
Aging (10 years)		$T_a = 25^\circ C$			$\pm 10$	ppm
Output Load		Differential		100		Ohms
Start-up Time	$T_{ST}$	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% $V_{PP}$		275	380	ps
Output Fall Time		80% to 20% $V_{PP}$		275	380	ps
Output Clock Duty Cycle	$T_{DTCY}$	At 50% $V_{PP}$	45		55	%
Output Enable/ Disable Time	$T_{OE}$				100	ns
Period Jitter, RMS	$J_{PER}$	Frequency = 156.25MHz		3.5	8	ps
Random Jitter	$R_J$	Frequency = 156.25MHz		0.9	1.5	ps
Deterministic Jitter	$D_J$	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		12	26	ps
Total Jitter	$T_J$			25	44	ps
Phase Jitter (12kHz – 20MHz)	$\phi_{JITTER}$	At $25^\circ C$ & 3.3V		300	400	fs
Phase Noise Performance Frequency = 156.25 MHz	$\phi_{NOISE}$	100Hz of Carrier		-97		dBc/Hz
		1kHz of Carrier		-112		dBc/Hz
		10kHz of Carrier		-122		dBc/Hz
		100kHz of Carrier		-131		dBc/Hz
		1MHz of Carrier		-146		dBc/Hz
		10MHz of Carrier		-153		dBc/Hz
Output Frequency (Standards)	$F_{OUT}$	100MHz, 106.25MHz, 125MHz, 150MHz, 155.52MHz, 156.25MHz, 200MHz, 212.5MHz, 250MHz, 300MHz, 312.5MHz, 400MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at  $25^\circ C$ . We do not recommend hand soldering the devices.

## DC Characteristics

( $V_{DD} = 2.5V \pm 5\%$ ,  $T_A = -20^\circ C$  to  $+70^\circ C$ ;  $-40^\circ$  to  $+85^\circ C$ ). Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	$I_{DD}$	Standard frequencies		75	90	mA
Differential Output Voltage	$V_{OD}$	Std LVDS load	0.25	0.45	0.55	V
Output Offset Voltage	$V_{OS}$	Std LVDS load	1.0	1.17	1.375	V
Enable/Disable Input HIGH Voltage (Output enabled)*	$V_{IH}$		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	$V_{IL}$				$30\%V_{DD}$	V

\* A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

## AC Characteristics

( $V_{DD} = 2.5V \pm 5\%$ ,  $T_A = -20^\circ C$  to  $+70^\circ C$ ;  $-40^\circ$  to  $+85^\circ C$ ). Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	$F_{OUTR}$		0.016		1350	MHz
Frequency Stability		Temperature = $-20^\circ C$ to $+70^\circ C$	$\pm 20$		$\pm 100$	ppm
		Temperature = $-40^\circ C$ to $+85^\circ C$	$\pm 25$		$\pm 100$	ppm
Output Load		Differential		100		Ohms
Start-up Time	$T_{ST}$	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% $V_{PP}$		300	400	ps
Output Fall Time		80% to 20% $V_{PP}$		300	400	ps
Output Clock Duty Cycle	$T_{DTCY}$	At 50% $V_{PP}$	45		55	%
Output Enable/ Disable Time	$T_{OE}$				100	ns
Period Jitter, RMS	$J_{PER}$	Frequency = 156.25MHz		5	9	ps
Random Jitter	$R_J$	Frequency = 156.25MHz		0.9	1.3	ps
Deterministic Jitter	$D_J$	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		10	18	ps
Total Jitter	$T_J$			25	36	ps
Phase Jitter (12kHz – 20MHz)	$\phi_{JITTER}$	At $25^\circ C$ & 2.5V		400	500	fs
Phase Noise Performance Frequency = 156.25MHz	$\phi_{NOISE}$	100Hz of Carrier		-97		dBc/Hz
		1kHz of Carrier		-114		dBc/Hz
		10kHz of Carrier		-120		dBc/Hz
		100kHz of Carrier		-127		dBc/Hz
		1MHz of Carrier		-146		dBc/Hz
		10MHz of Carrier		-153		dBc/Hz
Output Frequency (Standards)	$F_{OUT}$	100MHz, 106.25MHz, 125MHz, 150MHz, 155.52MHz, 156.25MHz, 200MHz, 212.5MHz, 250MHz, 300MHz, 312.5MHz, 400MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at  $25^\circ C$ . We do not recommend hand soldering the devices.

## DC Characteristics

( $V_{DD} = 1.8V \pm 5\%$ ,  $T_A = -20^\circ C$  to  $+70^\circ C$ ;  $-40^\circ$  to  $+85^\circ C$ ). Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	$I_{DD}$	Standard frequencies			65	mA
Differential Output Voltage	$V_{OD}$	Std LVDS load	0.25	0.4	0.5	V
Output Offset Voltage	$V_{OS}$	Std LVDS load		1.17		V
Enable/Disable Input HIGH Voltage (Output enabled)*	$V_{IH}$		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	$V_{IL}$				$30\%V_{DD}$	V

\* A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

## AC Characteristics

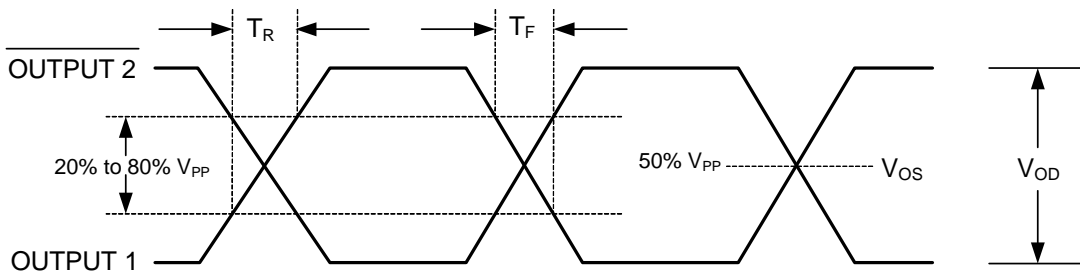
( $V_{DD} = 1.8V \pm 5\%$ ,  $T_A = -20^\circ C$  to  $+70^\circ C$ ;  $-40^\circ$  to  $+85^\circ C$ ). Below are guaranteed for listed standard frequencies.

Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	$F_{OUTR}$		0.016		1000	MHz
Frequency Stability		Temperature = $-20^\circ C$ to $+70^\circ C$	$\pm 20$		$\pm 100$	ppm
		Temperature = $-40^\circ C$ to $+85^\circ C$	$\pm 25$		$\pm 100$	ppm
Output Load		Differential		100		Ohms
Start-up Time	$T_{ST}$	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% $V_{PP}$		250	315	ps
Output Fall Time		80% to 20% $V_{PP}$		250	315	ps
Output Clock Duty Cycle	$T_{DTCY}$	$\leq 156.25MHz$	45		55	%
		$> 156.25MHz$	40		60	%
Output Enable/ Disable Time	$T_{OE}$				100	ns
Period Jitter, RMS	$J_{PER}$	Frequency = 156.25MHz		5	10	ps
Random Jitter	$R_J$	Frequency = 156.25MHz		2.0	3.8	ps
Deterministic Jitter	$D_J$	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		27	36	ps
Total Jitter	$T_J$			60	80	ps
Phase Jitter (12kHz – 20MHz)	$\phi_{JITTER}$	At $25^\circ C$ & 1.8V		800	1200	fs
Phase Noise Performance Frequency = 156.25MHz	$\phi_{NOISE}$	100Hz of Carrier		-91		dBc/Hz
		1kHz of Carrier		-107		dBc/Hz
		10kHz of Carrier		-111		dBc/Hz
		100kHz of Carrier		-121		dBc/Hz
		1MHz of Carrier		-143		dBc/Hz
		10MHz of Carrier		-147		dBc/Hz
Output Frequency (Standards)	$F_{OUT}$	100MHz, 106.25MHz, 125MHz, 150MHz, 155.52MHz, 156.25MHz, 200MHz, 212.5MHz, 250MHz, 300MHz, 312.5MHz, 400MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at  $25^\circ C$ . We do not recommend hand soldering the devices.

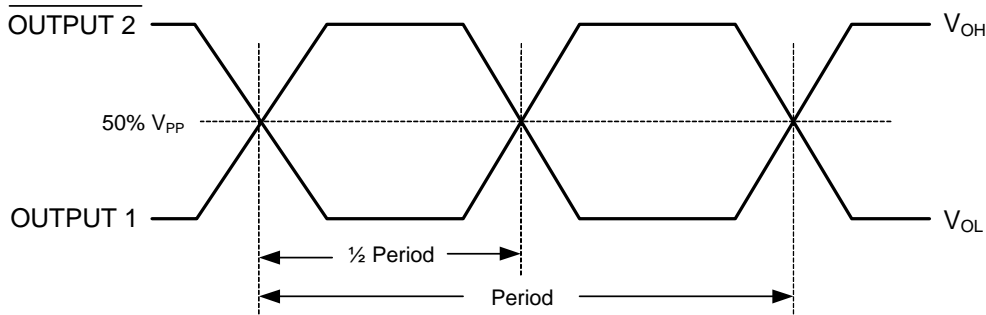
# Output Waveform

**Output Levels/Rise Time/Fall Time Measurements**

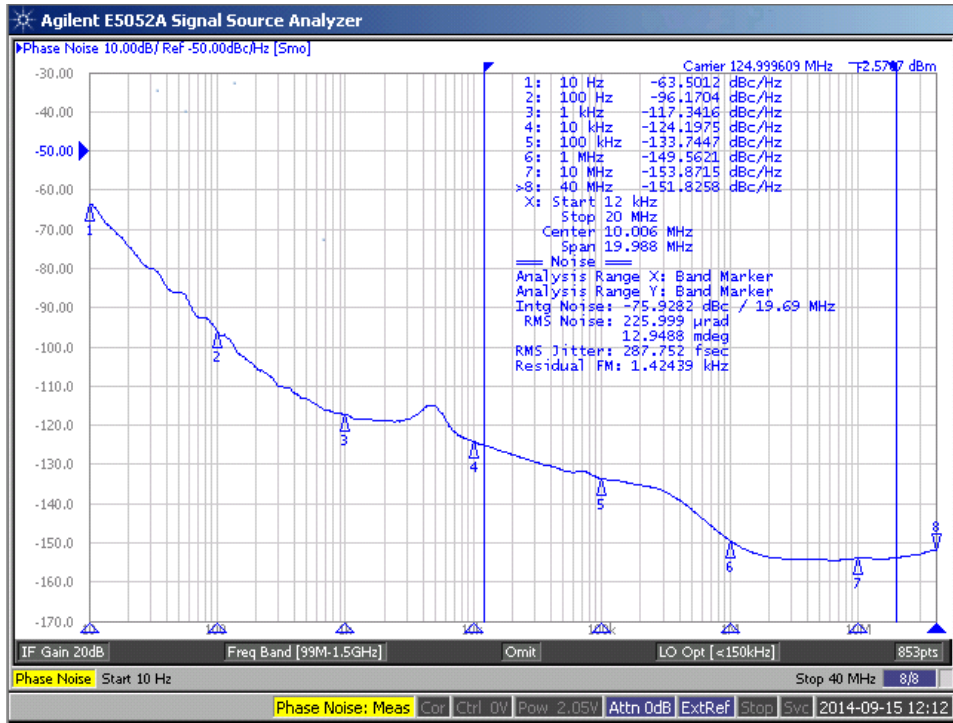


**Oscillator Symmetry**

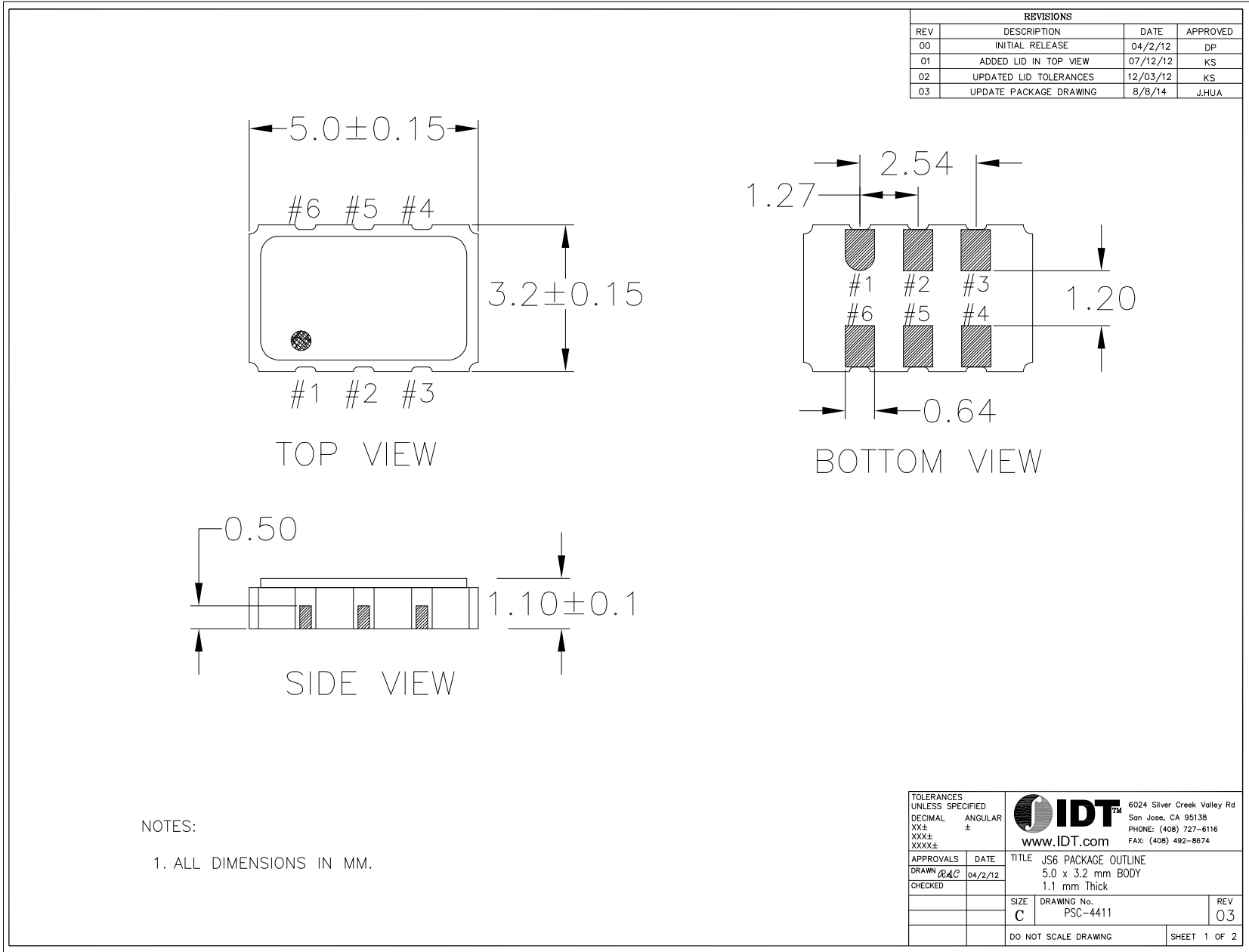
Ideally, Symmetry should be 50/50 for 1/2 period –Other expressions are 45/55 or 55/45



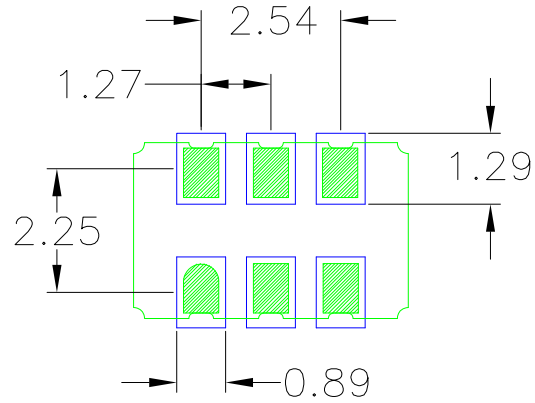
# Typical Phase Noise



JS6 Package Outline and Dimensions



# JS6 Package Outline and Dimensions (cont.)



RECOMMENDED LAND PATTERN

NOTES:

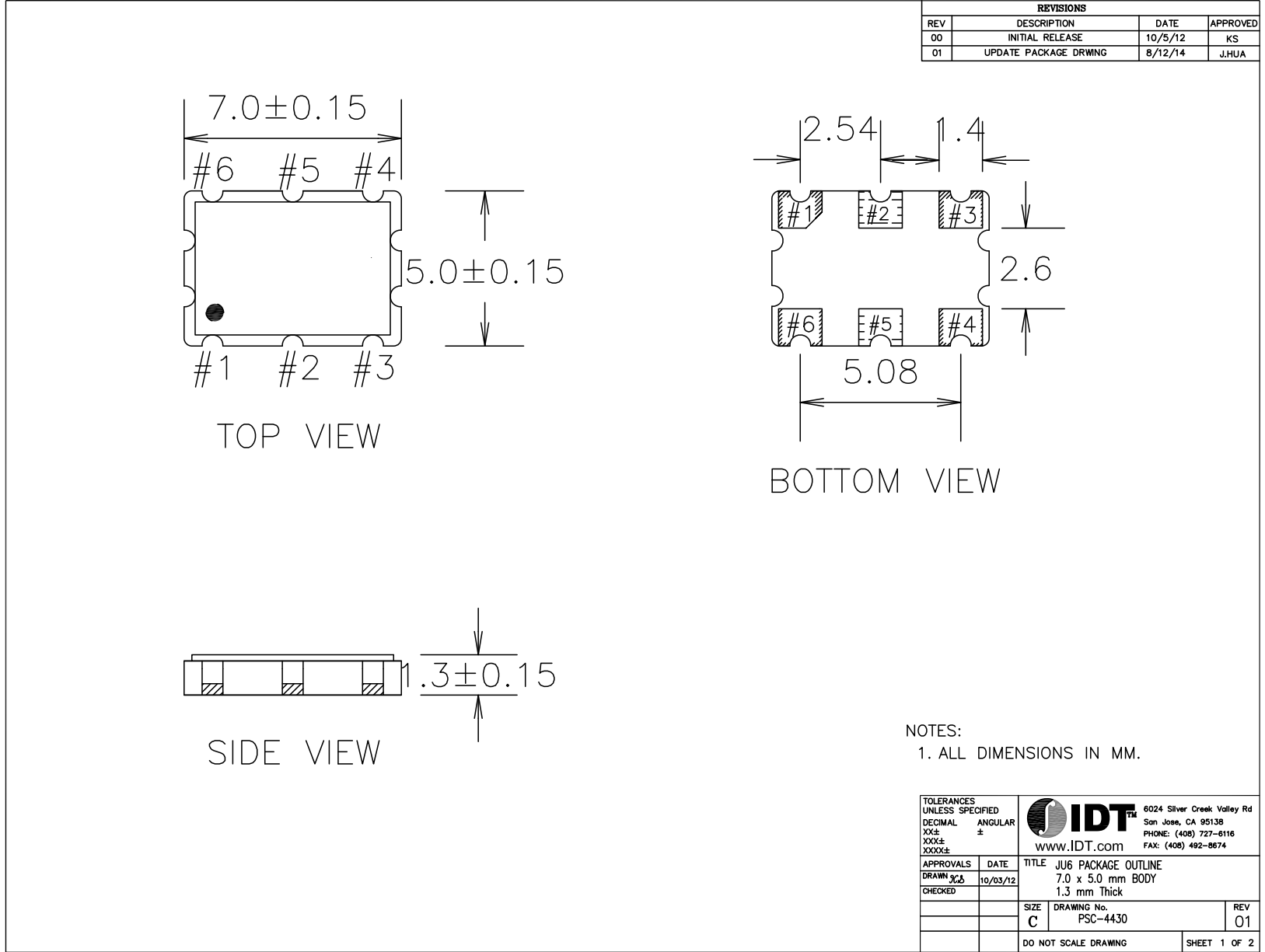
1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	04/2/12	DP
01	ADDED LID IN TOP VIEW	07/12/12	KS
02	UPDATED LID TOLERANCES	12/03/12	KS
03	UPDATE PACKAGE DRAWING	8/8/14	J.HUA

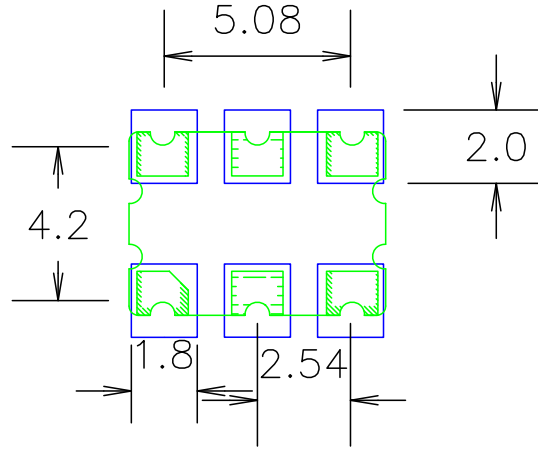
TOLERANCES UNLESS SPECIFIED		6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674 www.IDT.com
DECIMAL	ANGULAR	
XX±	±	
XXX±		
XXXX±		
APPROVALS	DATE	TITLE JS6 PACKAGE OUTLINE
DRAWN <i>rac</i>	04/2/12	5.0 x 3.2 mm BODY
CHECKED		1.1 mm Thick
	SIZE C	DRAWING No. PSC-4411
		REV 03
DO NOT SCALE DRAWING		SHEET 2 OF 2



JU6 Package Outline and Dimensions



# JU6 Package Outline and Dimensions (cont.)



RECOMMENDED LAND PATTERN

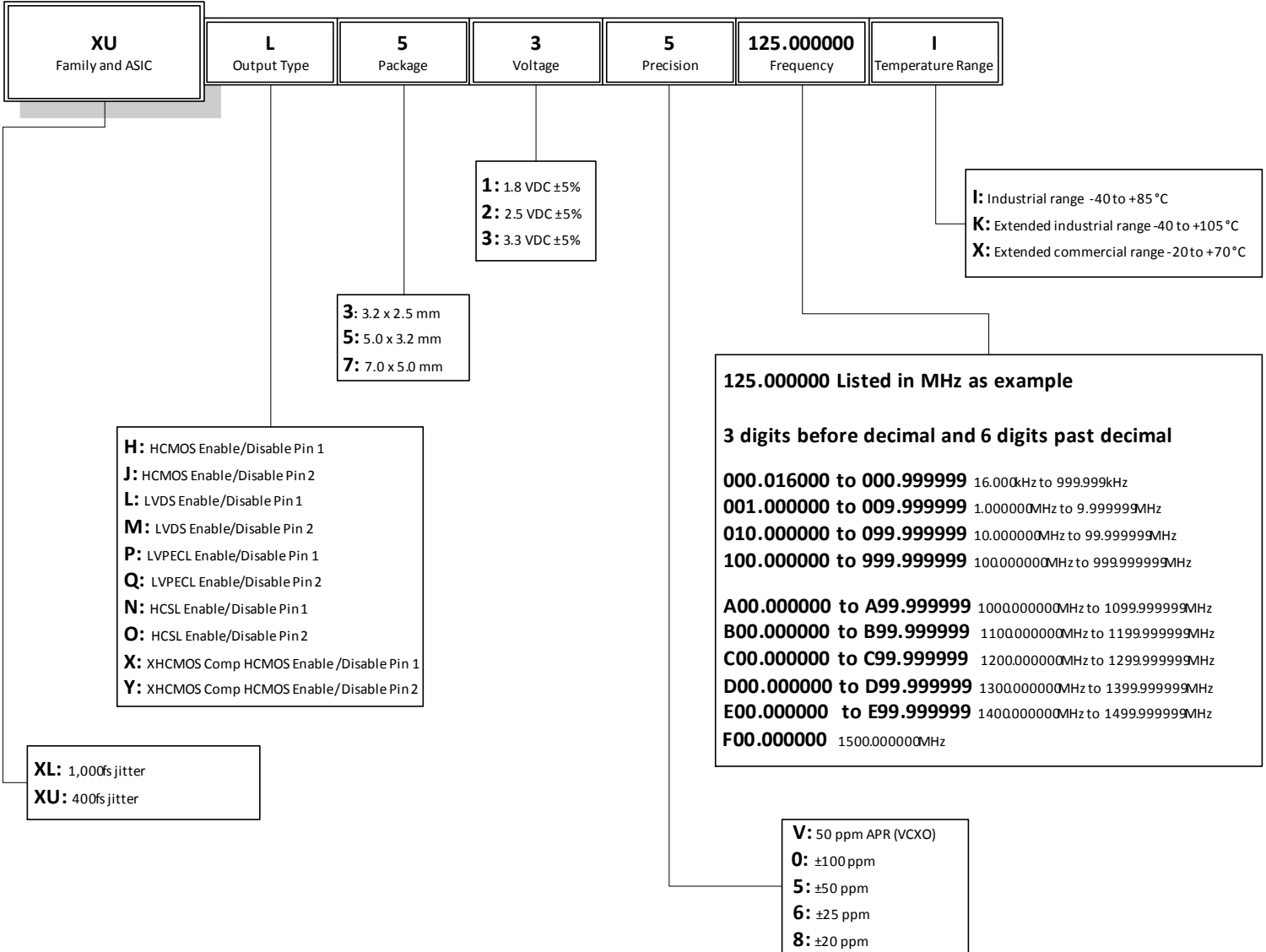
NOTES:

1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	10/5/12	KS
01	UPDATE PACKAGE DRWING	8/12/14	J.HUA

<b>TOLERANCES</b> UNLESS SPECIFIED DECIMAL    ANGULAR XX±        ± XXX± XXXX±		6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674 www.IDT.com
APPROVALS    DATE DRAWN <i>XCZ</i> 10/03/12 CHECKED	TITLE JU6 PACKAGE OUTLINE 7.0 x 5.0 mm BODY 1.3 mm Thick	
SIZE C	DRAWING No. PSC-4430	REV 01
DO NOT SCALE DRAWING		SHEET 2 OF 2

# IDT Ordering Information



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## Revision History

Date	Originator	Description of Change
01/16/15	B. Chandhoke	Initial release.
10/28/16	P. Jenkins	Update ordering information decoder tables by separating them into Scheme 1 and Scheme 2; add note to distinguish the two tables.
06/13/17	L.S.	Removed "Ordering Information Scheme #1 (for reference only)". Replaced with a single ordering information table.
06/20/17	L.S.	Corrected frequency errors in Ordering Information table.



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